

VSTF065R11ANA

Datasheet

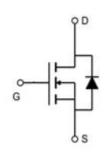
VMDSEMI



VSTF065R11ANA

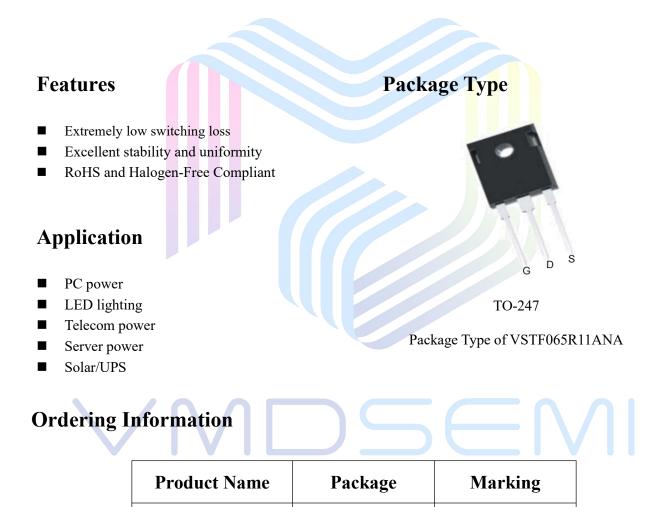
General Description

V _{(BR)DSS}	R _{DS(ON)_max}	ID
650V	110mΩ@10V	40A



Symbol

Symbol of VSTF065R11ANA



TO-247

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Absolute Maximum Ratings(T_J= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V _{DS}	650	V
Gate-Source Voltage		V _{GS}	±30	V
Continuous Drain Current Note 1	$T_C=25^{\circ}C$	ID	40	Α
Pulsed Drain Current Note 2	$T_C=25^{\circ}C$	I _{D, pulse}	120	Α
Continuous Diode Forward Current ^{Note 1}	$T_{\rm C}=25^{\rm o}{\rm C}$	Is	40	Α
Diode Pulsed Current Note 2	$T_C=25^{\circ}C$	I _{S, pulse}	120	А
Max Power Dissipation Note 3	$T_C=25^{\circ}C$	PD	480	W
Avalanche Current, Single Pulse Note 4		I _{AS}	17.2	Α
Avalanche Energy, Single Pulse Note4		Eas	1479	mJ
MOSFET dv/dt ruggedness, V _{DS} =0~480V		dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} =0~480V, I _{SD} <= I _D		dv/dt	15	V/ns
Operation and storage temperature		T _J ,T _{STG}	- <mark>5</mark> 5 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit	
Thermal Resistance, Junction-to-Case	R _{0JC}	-	0.26	-	°C/W	
Thermal Resistance, Junction-to-Ambient Note5	R _{0JA}	-	62.5	-		

Notes:

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4: V_{DD} =50V, V_{GS} =10V, L=10mH, R_G =25 Ω , starting T_A =25 °C.

Note5: When mounted on 1 inch square copper board, t \leq 10sec. The value in any given application depends on the user's specific board design.



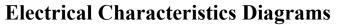
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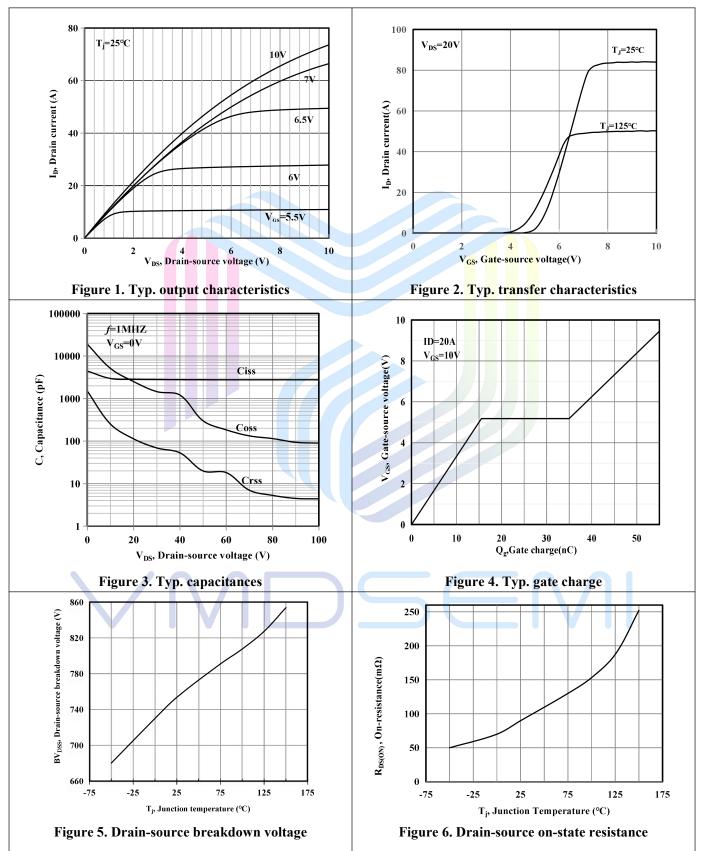
Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics			1	1		1	
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250uA	650	-	-	V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =650V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	Forward	I _{GSSF}	V _{GS} =30V, V _{DS} =0V	-	-	100	nA
	Reverse	I _{GSSR}	V_{GS} =-30V, V_{DS} =0V	-	-	-100	
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.8	3.7	4.2	V
Drain-Source On-State Resistan	ce	R _{DS(ON)}	V _{GS} =10V, I _D =15A	-	87	110	mΩ
Gate Resistance		R _G	F=1MHz, Open Drain	-	4.4	-	Ω
Dynamic Characteristics							
Input Capacitance		Ciss	V _{DS} =50V		2780	-	pF
Output Capacitance		Coss	V _{GS} =0V	-	300	-	pF
Reverse Transfer Capacitance		C _{rss}	f=1MHz	-	19.9	-	pF
Turn-on Delay Time		t _{d(on)}	V _{DS} =400V	-	16.54	-	
Rise Time		t _r	I _D =20A	-	5.23	-	
Turn-off Delay Time		$t_{d(off)}$	$R_G=2\Omega$	-	51.63	-	ns
Fall Time		t _f	V _{GS} =10V	-	7.1	-	
Gate Charge Characteristics							
Gate to Source Charge		Q_{gs}	V -400V	-	15.52	-	
Gate to Drain Charge		Q_{gd}	$V_{DS}=400V$ $I_{D}=20A$	- /	19.46	-	nC
Gate Charge Total		Qg	$V_{GS}=0$ to 10V	-	57.6	-	
Gate Plateau Voltage		VPlateau			5.18	-	V
Reverse Diode Characteristics	6						
Drain-Source Diode Forward Vo	oltage	V_{SD}	$V_{GS}=0V, I_S=1A$	-	0.7	1.4	V
Reverse Recovery Time		t _{rr}	V _R =400V	-	470	-	ns
Reverse Recovery Charge		Q _{rr}	$I_{\rm S}=20A$	-	4501	-	nC
Peak Reverse Recovery Current		I _{rrm}	di/dt=100A/us	-	34.4	- 1	А
			SE		V		

Electrical Characteristics (T_J= 25 °C, unless otherwise specified)



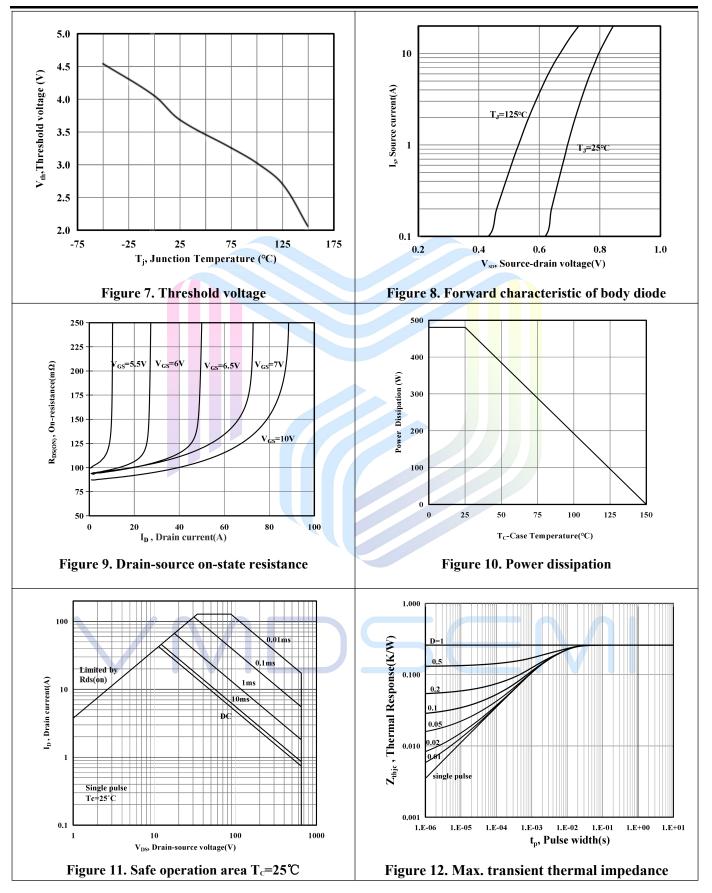
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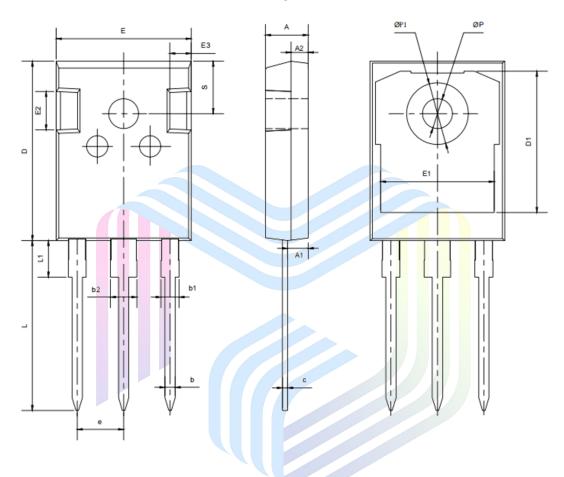


110m Ω , 650V, N-Channel Power MOSFET

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Mechanical Dimensions

TO-247 Package Information



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	MAX	1
A	4.80	5.20	
 A1	2.21	2.61	
A2	1.85	2.15	
b	1.11	1.36	
b1	1.91	2.21	
b2	2.91	3.21	
С	0.51	0.75	
D	20.70	21.30	1
D1	16.25	16.85	
E	15.50	16.10	1
E1	13.00	13.60	1
E2	4.80	5.60	1
E3	2.10	2.70	1
e	5.44BSC		1
L	19.62	20.22	
L1	-	4.30	
φΡ	3.40	3.80	
φΡ1	-	7.30	
S	6.15	BSC	

 $\in M$



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